

INTERNATIONAL STANDARD

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**OPC Unified architecture -
Part 21: Device Onboarding**

**Architecture unifiée OPC -
Partie 21: Mise en service d'appareils**

IEC 62541-21:2026

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Draft	Report on voting
65E/1046/CDV	65E/1103/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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